



Build Vishay into your Design



THIN FILM NA RESISTORS PRECISION DIVIDERS AND NETWORKS

MATCHED PAIRS

MP, MPM, MPD (SC70, SOT23, SOT143) SERIES



MATCHED NETWORKS

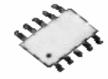
ORN, NOMC, OSOP (SOIC 8, 14, 16, 20) SERIES CSO CUSTOMS

MARKET TRENDS









- > TRANSITIONING AWAY FROM CUSTOMS TO STANDARD OFF-THE-SHELF VALUES USING STANDARD FORMATS
- > OPPORTUNITIES IN INDUSTRIAL, INSTRUMENTATION, AND TEST AND MEASURMENT APPLICATIONS
- MOBILE APPLICATIONS NEED TO HAVE SMALL SIZE AND IMPROVED FUNCTIONALITY



Yes

Yes

MPM/MP/MPDA SERIES – PRECISION MATCHED PAIRS AND DIVIDERS



• FEATURES

- Matched pair resistors
- Small size (SOT-23, SC70, SOT-143 packages)
- Tight resistance ratio tolerances (+/- 0.01 % on equal values)
- Low TC tracking (+/- 2.0 ppm)
- Excellent long term stability(+/- 0.03 % delta R ratio 2000 hours @ 70 deg. C
- Available lead (Pb) and lead (Pb)-free e3 solder (RoHS)

Pb	
	SAMPLES:
	L-TIME:

1 week

PUSH ('05)

-TIME: Stock - 4 wks

DATA SHEET:

BUD-PRICE:

SIGNAL CONDITIONING

- FREQUENCY COUNTERS

- AUTOMATIC TEST EQUIPMENT

-RADIOGRAPHY FILM PROCESSING

- PROCESS CONTROLS

- TEST EQUIPMENT - DATA ACQUISITION

EQUIPMENT

Released

On WEB

\$0.50 to \$0.95 EA

Respons.

G. Giambra

TARGET APPLICATIONS

DESCRIPTION / REMARKS

- Ratio tolerances of +/- 0.025 % and +/-0.01 % not offered by competition
- Inventory of popular divider ratios (1:1 to 100:1)
- Custom divider ratios available
- Datasheet: http://www.vishay.com/docs/60001/mpm.pdf Datasheet: http://www.vishay.com/docs/60092/mpseries.pdf
- Datasheet: http://www.vishay.com/docs/60016/mpmpda.pdf

Main Competitors and Products: IRC (SOT)

BI Technologies (SS103)

Maxim (MAX5490)

KOA (RTY)

AMS

MEDICAL

TELECOM

CONSUM

INDUST

COMP

- ENGINE CONTROLS - NIGHT VISION SYSTEMS

- INSTRUMENTATION



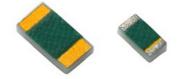
THIN FILM RESISTORS PRECISION CHIP RESISTORS

QPL MIL APPROVED
MIL-PRF-55342 SERIES



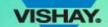
INDUSTRIAL PRECISION

P, PTN, M, FC SERIES



MARKET TRENDS

- > TRANSITIONING TO STANDARD SMALLER FORMATS
- > OPPORTUNITIES IN APPLICATIONS THAT REQUIRE HIGH RELIABILITY, STABLE PERFORMANCE, AND HIGH FREQUENCY
- MOBIL APPLICATIONS NEED TO HAVE SMALL SIZE AND IMPROVED FUNCTIONALITY



PTN SERIES – TANTALUM NITRIDE CHIP RESISTORS

PTN SERIES



• FEATURES

- Moisture-impervious
- Precision (\pm 0.1 % tol and \pm 25 ppm/C TCR)
- Very low noise: < -35 dB and voltage coefficient 0.1 ppm/v
- Available lead or lead (Pb)-free (e1) solder (RoHS)
- Non-std. values available (i.e., 24.9563 kohms)

STATUS:	MATURE ('95)	
SAMPLES:	1 weeks	
L-TIME:	8 – 12 weeks	
DATA SHEET:	Released	YES
	On WEB	YES
BUD-PRICE:	\$0.25 - \$0.50 ea.	
Respons.	A. Tapani	

DESCRIPTION / REMARKS

- Self-passivated tantalum nitride resistor film
- Custom resistor values: 10 3 Mohms
- Power ratings to 2 watts
- Available in 12 chip case sizes: 0402 thru 2512
- Datasheet: http://www.vishay.com/docs/60026/ptn.pdf
- Sales sheet: VMN-PT9187-0605

Main Competitors and Products: IRC (PFC Series)
 Mini Systems (WATF Series)

TARGET APPLICATIONS

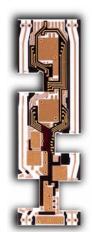
MEDICAL	
TELECOM	- BASE STATIONS
COMP	- MOBILE COMMUNICATIONS, SERVERS
CONSUM	
INDUST	- POWER SUPPLIES - VOLTAGE REGULATORS - TEST INSTRUMENTS
<u>AutoL</u>	
<u>AMS</u>	- COMMUNICATIONS - GUIDANCE AND CONTROL SYSTEMS - MISSILES - SATELLITES



THIN FILM NA RESISTORS PATTERN SUBSTRATES USING THIN FILM TECHNOLOGY

- SUBSTRATES
- METAL SYSTEMS
- RESISTORS
- VIA HOLES
- PASSIVATION AND SOLDER BARRIERS
- LASER MACHINING

- Al₂O₃, AlN, BeO, ferrite, garnet
- Cr, TiW, NiCr, Pd, Pt, Ni, Cu, Au
- Ta₂N, NiCr, CrSiO
- Plated, filled, Au or Cu
- SiO₂, Si₃N₄, polyimide, nickel oxide, low-temperature polymer
- Cutouts and custom shapes

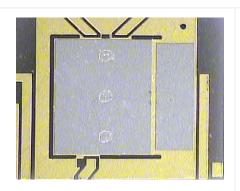


MARKET TRENDS

- > TRANSITIONING AWAY FROM GOLD/TIN PREFORMS TO DIRECTLY DEPOSITED, CONTROLLED GOLD/TIN
- > OPPORTUNITIES IN SUBASSEMBLIES THAT REQUIRE THERMAL MANAGEMENT, SPECIAL SHAPES, AND SMALL SIZES



AuSn SERIES - LASER SUBMOUNTS



FEATURES

- Custom layout to fit application
- Gold/tin die mount area
- 80/20 AuSn integrated composition
- Freeze time: 120 seconds @ 320 C
- Substrate choices: Aln, BeO, Al203
- Multiple substrate thicknesses available



STATUS:	NEW ('06)	
SAMPLES:	3 – 4 weeks	
L-TIME:	6 – 10 weeks	
DATA SHEET:	Released	YES
	On WEB	YES
BUD-PRICE:	\$7.00 - \$10.00 Ea.	
Respons.	D. Coulton	

DESCRIPTION / REMARKS

- Thin film metallization stack with AuSn
- Optional solid filled gold or copper vias for thermal dissipation or electrical through substrate connection
- Provides precise component placement to +/-0.0005 inches
- Eliminates conventional pre-forms for mounting
- Datasheet: http://www.vishay.com/doc/61081
- Sales sheet: VMN-PT9187-0605
- Main Competitors: Ultrasource, Rhinehardt

TARGET APPLICATIONS

TELECOM	-LASER SUBMOUNTS: - OPTICAL RECEIVERS / TRANSCEIVERS - TOSA/ROSA PACKAGES - DIODE LASERS
COMP	
CONSUM	
INDUST	
MEDICAL	
<u>AMS</u>	